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INFLUENCE OF THE SUBSTRATE ON THE STRUCTURE STABILITY LaLuO₃ THIN FILMS DEPOSITED BY PLD METHOD

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ABSTRACT

LaLuO₃ amorphous thin films were elaborated by pulsed laser deposition technique on different support: Si (100), Si(100) with buffer layer CeO₂, MgO(111) and Al₂O₃ (1101). For obtained the crystallizes phase the thin films were annealed in temperature 1100 °C in air during 2 h. TEM analysis clearly showed the reaction between Si support and LaLuO₃ thin films and their polycrystalline structure. The spectroscopy investigations indicate the reaction between Si support and LaLuO₃ thin films and formation of silicates. The CeO₂ thin buffer layers on Si support limited the reaction between support and thin films. No reactions were observed between the surface Al₂O₃ and MgO and thin films.

KEYWORDS

Thin films LaLuO₃, PLD, XPS

1. INTRODUCTION

One of the most important processes in the MOSFET(*Metal-Oxide Semiconductor Field-Effect Transistor*) technology is the gate dielectric deposition. The silicon technology of excellent quality natural gate dielectric in the form of SiO_2 has become the driving force in the development of microelectronics. Currently, however, other

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